

## भारतीय सूचना प्रौद्योगिकी, अभिकल्पना एवं विनिर्माण संस्थान, कांचीपुरम Indian Institute of Information Technology, Design and Manufacturing, Kancheepuram

Dean (SR,IC&CE) Office

## Approval for Faculty (P.Is) to participate / present research papers at International/National Conferences/Workshop from Sponsored Projects

A.	Details of the P.I  1. Name  2. Designation  3. Department  4. Sponsored Project No. /Agency	: : : :		
В.	Details of the International/ National Conferences  1. Title	s/W	'orkshop, held in India ε	etc
	<ul><li>2. Organized by</li><li>3. Duration</li><li>4. Venue</li></ul>	:		
C.	Details of the Paper (a)Whether accepted for Oral / Poster presentation? (b) Name(s) of Co-author(s) with designations	:		
D.	Visits Abroad during last 3 years (International Conference/Workshop Only)	:		
	Countries Visited Period	d		Purpose
E.	Whether the reports on the above (D) visits were submitted	:		
F.	Whether all the supporting documents referred in the checklist (I. Enclosure ) are enclosed?	:		
G.	Leave / Attendance details			
	Details of proposal of the leave or with attendance to be availed During this period (to be specified)		From	То
	(Maximum of 2 days before & after the conference	e d	lays only will be permit	ted for out station events)

Note: Per diem (Food allowance) and Room rent are admissible maximum for conference days plus 2 days (1 day prior and 1 day after) or at actuals whichever is less. Overstay, if any, is not permitted unless otherwise approved by the competent authority as a special case.

## H. Funding Arrangement

S.No	Particulars	Request
I	International Air fare (Rs.)	
II	Internal Travel (provide details)	
III	Visa fee	
IV	Travel Insurance	
V	Registration Fee	
VI	Cash allowance per diem  @US \$ for Days	
VII	Accomodation charges  @US \$ for Days	
VIII	Other charges (if any)	
IX	Total in US \$ * (dollar rate approx)	
X	Total in INR	

I. Enclosure :Supporting Documents (Attach the following applicable documents)

Attachment No	<b>Supporting Documents</b>	Attachi	ent Status				
i.	Justification to attend the conference / workshop	Attached	☐ Not Applicable				
ii.	Letter of Invitation	Attached	Not Applicable				
iii.	Acceptance of the Paper & Review comments	Attached	☐ Not Applicable				
iv.	Conference brochure and Registration fee details	Attached	☐ Not Applicable				
v.	Supporting documents for Airfare	Attached	☐ Not Applicable				
vi.	Accommodation cost / details with supporting documents	Attached	☐ Not Applicable				
vii.	Details of external funding, if any	Attached	☐ Not Applicable				
viii.	Copy of the full paper	Attached	☐ Not Applicable				
Recommendati	on of HOD		Signature of P.I				
Kecommendan	on or HOD		Signature of HOD				
Remarks by S	by AR(Sricce)						
Signature of I	Dealing Assistant	Signature					
<b>T</b>	(db)		<b>7</b>				
Dean(	SR)		Registrar				
APPROVED / NOT APPROVED							
Director							